

September 26, 2008

LM49450 Boomer[®] Audio Power Amplifier Series I²S Input, 2.5W/Channel, Low EMI, Stereo, Class D Audio Sub-System with Ground Referenced Headphone Amplifier, 3D Enhancement, and Headphone Sense

General Description

The LM49450 is a fully integrated audio subsystem designed for portable media player applications. The LM49450 combines a 24-bit I2S digital-to-analog converter (DAC), 2.5W/ channel stereo Class D speaker drivers, 36mW stereo ground referenced headphone drivers, volume control, and National's unique 3D sound enhancement into a single device.

The filterless Class D amplifiers deliver 1.25W/channel into an 8 Ω load with <1% THD+N with a 5V supply. The LM49450 offers two logic selectable modulation schemes, fixed frequency mode, and an EMI reducing spread spectrum mode. The 36mW/channel headphone drivers feature National's ground referenced architecture that creates a ground-referenced output from a single supply, eliminating the need for bulky and expensive DC-blocking capacitors, saving space and minimizing system cost. A headphone sense input (HPS) automatically detects the presence of a headphone, and configures the device accordingly.

The LM49450 stereo, 24-bit DAC supports a wide range of sample rates (including 192kHz, 96kHz, 48kHz, and 44.1kHz). The digital audio signal path features better than 100dB SNR, and low 0.05% THD+N when measured at the headphone outputs. The flexible 3-wire I²S interface supports left or right justified audio data.

The LM49450 features separate 32-step volume control for the headphones and speaker outputs. 3D enhancement. mode selection, shutdown control, and volume are controlled through an I²C compatible interface.

Output short circuit and thermal overload protection prevent the device from being damaged during fault conditions. Superior click and pop suppression eliminates audible transients on power-up/down and during shutdown. The LM49450 is available in a space saving 32-pin LLP package.

Key Specifications

- SNR at Headphone Output 102dBA (typ) Speaker Amplifier Efficiency
- at 3.6V, 650mW/channel into 8Ω 87% (typ) Speaker Amplifier Efficiency at 5V, 1.1W/channel into 8Ω 80% (typ) Quiescent Power Supply Current Line Inputs: Speaker Mode at LSV_{DD} = 3.6V 7.5mA (typ) Headphone Mode at HPV_{DD} = 2.5V

- Output Power/Channel
- Speaker at LSV_{DD} = 5V:

R _L = 4Ω, THD+N ≤ 10%	2.5W (typ)
$R_{L} = 4\Omega$, THD+N $\leq 10\%$	2.5VV (typ

 $R_1 = 8\Omega$, THD+N $\leq 1\%$ 1.25W (typ)

Headphone at $HPV_{DD} = 2.5V$:

- $R_1 = 16\Omega$, THD+N $\leq 1\%$ 34mW (typ)
- $R_1 = 32\Omega$, THD+N $\leq 1\%$
- PSRR at 1kHz Speaker Mode Headphone Mode
- Shutdown current

0.02µA (typ)

36mW (typ)

67dB (typ)

77dB (typ)

Features

- 24-Bit Stereo DAC
- Stereo Filterless Class D Operation
- Selectable spread spectrum mode reduces EMI
- Ground Referenced Headphone Amplifiers with 100dB SNR
- I²S Compatible Audio Interface
- Audio Sample Rates up to 192kHz
- National's 3D Enhancement
- 32-step Digital Volume Control
- I²C Compatible Control Interface
- Headphone Sense Input
- Stereo Analog Line Inputs
- **Output Short Circuit Protection**
- Thermal Overload Protection
- Minimum external components
- Click and Pop suppression
- Micro-power shutdown
- Available in space-saving 32 pin LLP package

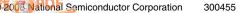
Applications

- Portable Media Players
- Portable Navigation Devices
- Multi-Media Monitors
- Laptops

5.3mA (typ)

- Portable Gaming Devices
- Mobile Handsets

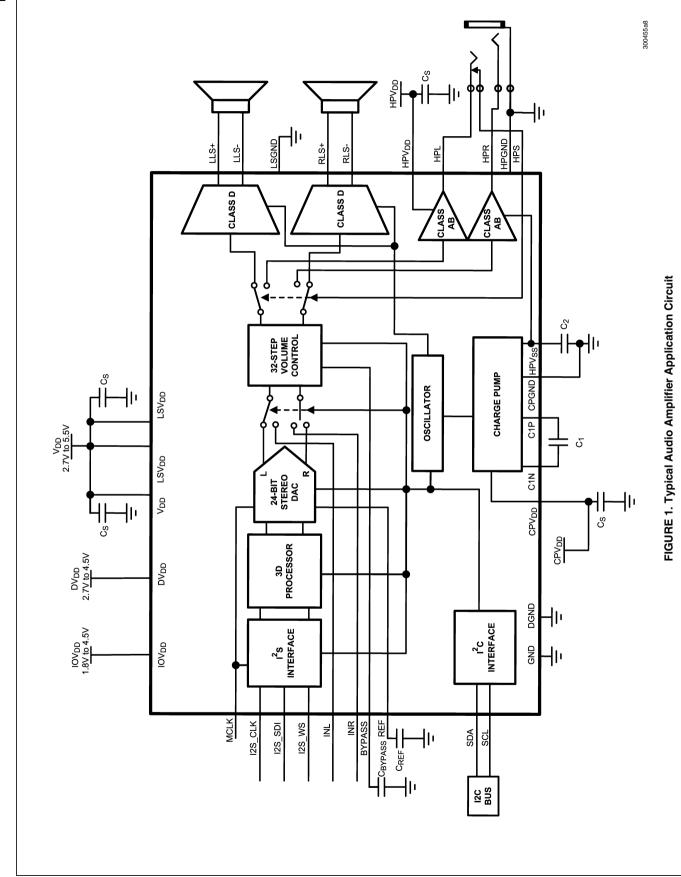
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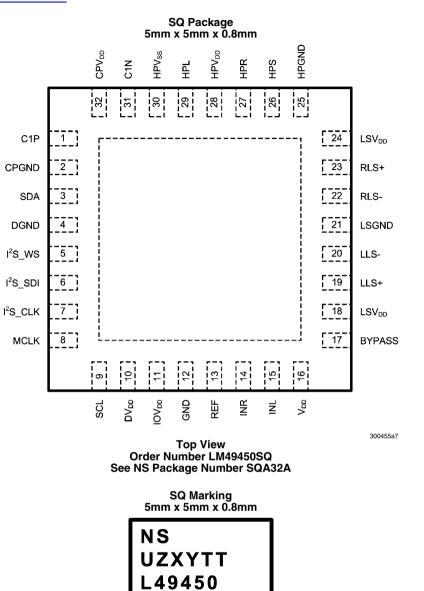
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Typical Application 查询"LM49450"供应商



Connegtion Diagrams



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LM49450

Top View NS - NS Logo U - Wafer Fab Code Z - Assembly Plant XY - 2 Digit Date Code TT - Lot Traceability L49450 - LM49450SQ

Absolute Maximum Ratings (Notes 1, 2)

间"II_M49450"供应商 IFMIIIHary/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Supply Voltage (Note 1) 6.0V Storage Temperature -65°C to +150°C Input Voltage -0.3V to V_{DD} +0.3V Power Dissipation (Note 3) Internally Limited ESD Susceptibility(Note 4) 2000V ESD Susceptibility (Note 5) 200V Junction Temperature (T_{JMAX}) 150°C Thermal Resistance

θ _{JC}	2.4°C/W
θ_{JA}	28.4°C/W

Operating Ratings (Notes 1, 2)

Temperature Range

$T_{MIN} \le T_A \le T_{MAX}$	$-40^{\circ}C \le T_A \le +85^{\circ}C$
Supply Voltage (V _{DD} , LSV _{DD})	$2.7V \le V_{DD} \le 5.5V$
Headphone Supply Voltage (CPV _{DD} , HPV _{DD})	$1.8V \le V_{DD} \le 2.7V$
Digital Core Supply Voltage (DV _{DD})	$2.7 \mathrm{V} \leq \mathrm{DV}_{\mathrm{DD}} \leq 4.5 \mathrm{V}$
Digital IO Supply Voltage (IOV _{סס})	$1.8V \le IOV_{DD} \le 4.5V$

Electrical Characteristics $V_{DD} = LSV_{DD} = 3.6V$, $HPV_{DD} = CPV_{DD} = 2.5V$ (Notes 2, 8) The following specifications apply for Headphone: $A_V = 0dB$, $R_{L(LS)} = 8\Omega$, $R_{L(HP)} = 32\Omega$, f = 1kHz, $C_1 = C_2 = 2.2\mu$ F, unless otherwise specified. Limits apply for $T_A = 25^{\circ}$ C.

			LM4	9450	Units (Limits)
Symbol	Parameter	Conditions	Typical	Limit	
			(Note 6)	(Note 7)	
DI _{DD}	Digital Core Supply Current	$DV_{DD} = 2.7V, f_S = 48kHz,$ $f_{MCLK} = 12.28MHz$	9	11.2	mA (max
I _{SD}	Shutdown Supply Current	Digital Current Analog Current	0.03 0.02	1	μΑ (max μΑ (max
SPEAKER AM	IPLIFIERS (Headphone Amplifiers	s Disabled, HPS = 0)		1	
DDLS	Analog Supply Current	f _S = 48kHz, DAC Active, No Load Line Inputs Active, No Load	9.8 7	13 10	mA (max mA (max
V _{OS}	Output Offset Voltage	DAC Active Line Inputs Active	8 8	45	mV (max mV (max
P _{OUT} Output Power	$R_{L} = 4\Omega, f = 1 \text{kHz}$ THD+N = 1% THD+N = 10%	1 1.2		w w	
		$R_{L} = 8\Omega, f = 1kHz$ THD+N = 1% THD+N = 10%	625 725	525	mW (mir W
		$P_0 = 300 \text{mW}, \text{ f} = 1 \text{ kHz}, \text{ R}_L = 8 \Omega$			
THD+N	Total Harmonic Distortion	DAC Active	0.06		%
		Line Inputs Active	0.07		%
		$V_{RIPPLE} = 200 m V_{P-P}, f = 1 k Hz$			
PSRR	Power Supply Rejection Ratio	DAC Active, Internal Reference	59	45	dB (min
ronn		DAC Active, External Reference	62		dB
		Line Inputs Active	67		dB
η	Efficiency	$P_O = 650, f = 1 \text{kHz}$ $R_L = 8\Omega$	87		%
		$P_0 = 500 \text{mW}, \text{ f} = 1 \text{ kHz}, \text{ R}_L = 8 \Omega$		•	
		DAC Active, Line Inputs Active	81 77		dB dB
Xtalk	Crosstalk	$P_0 = 500 \text{mW}, \text{ f} = 10 \text{kHz}, \text{ R}_{\text{L}} = 8\Omega$			
		DAC Active,	60		dB
		Line Inputs Active	60		dB

				9450	Units
Symbia ¹ 即	"LM49450"# 供表应应商 r	Conditions	Typical Limit		– (Limits
			(Note 6)	(Note 7)	(2
		$P_0 = 500 \text{mW}, \text{ f} = 1 \text{kHz}, \text{ A-weighted}$			
SNR	Signal to Noise Ratio	DAC Active, Internal Reference	89		dB
ONT		DAC Active, External Reference	92		dB
		Line Inputs Active	90		dB
		Maximum Gain Setting, Line Inputs	23.6	22.5	dB (mir
A _V	Digitally Controlled Gain Level	Active	20.0	24.1	dB (ma
v		Minimum Gain Setting, Line Inputs	-48	-49	dB (mir
		Active		-46	dB (ma
Mute	Mute Attenuation	Line Inputs Active	-91		dB
ΔA _{CH-CH}	Channel-to-Channel Gain		0.3		dB
	Matching				
		Input Referred, A-weighted	10.5	[
ε _{OS}	Output Noise	DAC Active, Internal Reference	43.5		μV
00		DAC Active, External Reference	45.4		μV
		Line Inputs Active	40		μV
t _{on}	Turn-On Time		27		ms
t _{OFF}	Turn-Off Time		1		ms
HEADPHONE A	AMPLIFIERS (Speaker Amplifiers	s Disabled, HPS = 1)			
I	Analog Supply Current	f _S = 48kHz, DAC active	7.2	8.25	mA (ma
DDHP		Line Inputs Active	5.3	6.5	mA (ma
V _{os}	Output Offset Voltage	DAC active, $A_V = -6dB$	7	30	mV
• OS	Output Onset Voltage	Line Inputs Active, , $A_V = -6dB$	5	00	mV (ma
		$R_L = 16\Omega, f = 1kHz$			
		THD+N = 1%, Single Channel	66		mW
		THD+N = 1%, Two Channels in	34		m\\/
Po	Output Power	Phase	34		mW
0		$R_L = 32\Omega$, f = 1kHz			
		THD+N = 1%, Single Channel	49	42	mW (mi
		THD+N = 1%, Two Channels in	26	07	m\\/ (mi
		Phase	36	27	mW (mi
		f = 1kHz, DAC Active			
THD+N	Total Harmonic Distortion	$R_{L} = 16\Omega, P_{O} = 5mW$	0.05		%
		$R_{L} = 32\Omega, P_{O} = 5mW$	0.03		%
		$V_{\text{RIPPLE}} = 200 \text{mV}_{\text{P-P}}, \text{ f} = 1 \text{kHz}$			
		DAC Active, Internal Reference	71.2	56	dB (min)
PSRR	Power Supply Rejection Ratio	DAC Active, External Reference	71.3		dB (IIIII)
		Line Inputs Active	76.9		dB
		$P_{\Omega} = 5$ mW, f = 1kHz, R _L = 32 Ω	10.0		40
		DAC Active, $1 = 1112, 112 = 0222$	82	[dB
		Line Inputs Active	79		dB
Xtalk	Crosstalk	$P_0 = 5$ mW, f = 10kHz, R _L = 32 Ω			40
			70		٦Ŀ
		DAC Active, Line Inputs Active	78 76		dB dB
		-	70	[
		$P_0 = 5mW$, f = 1kHz, A-weighted	00		-10
SNR	Signal to Noise Ratio	DAC Active, Internal Reference	99		dB
		DAC Active, External Reference	102		dB

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	0"供应商Parameter	Conditions	Typical	Limit	Units
			(Note 6)	(Note 7)	– (Limits)
		Maximum Gain Setting, Line Inputs	17.8	17.0	dB (min)
A _V	Digitally Controlled Gain Level	Active		18.5	dB (max)
v		Minimum Gain Setting, Line Inputs Active	-53.8	-56 -52	dB (min) dB (max)
Mute	Mute Attenuation	Line Inputs Active	-102		dB
ΔA _{CH-CH}	Channel-to-Channel Gain Matching		0.3		dB
		Input Referred, A-weighted		•	
	Output Noise	DAC Active, Internal Reference	10		μV
ε _{OS}		DAC Active, External Reference	10		μV
		Line Inputs Active	10		μV
V _{OUT_FS}	Full-Scale Headphone Amplifier Output Voltage	R _L = No Load	942	850	mV _{RMS} (min)
t _{on}	Turn-On Time		27		ms
t _{OFF}	Turn-Off Time		1		ms
HEADPHONE S	ENSE INPUT (HPS)	•			-
V _{IH}	Input High Voltage		1		V
V _{IL}	Input Low Voltage		0.6		V
DIGITAL INTER	FACE	•		•	<u> </u>
V _{IH}	Input High Voltage			2.8	V (min)
V _{IL}	Input Low Voltage			0.8	V (max)
V _{OH}	Output High Voltage			2	V (min)
V _{OL}	Output Low Voltage			1	V (max)

Electrical Characteristics $V_{DD} = LSV_{DD} = 5.0V$ (Notes 2, 8) The following specifications apply for Headphone: $A_V = 0dB$, $R_{L(LS)} = 8\Omega$, $R_{L(HP)} = 32\Omega$, f = 1kHz, unless otherwise specified. Limits apply for $T_A = 25^{\circ}C$.

	Parameter		LM49450		
Symbol		Conditions	Typical	Limit	Units (Limits)
			(Note 6)	(Note 7)	
SPEAKER AMP	PLIFIERS (Headphone Amplifiers	Disabled, HPS = 0)			
1	Anglan Oursely Ourset	f _s = 48kHz, DAC Active	14	18	mA (max)
DDLS	Analog Supply Current	Line Inputs Active	10.4	16	mA (max)
V	Output Offset Voltage	DAC Voltage	15	50	mV (max)
V _{os}	Output Onset Voltage	AV = 0dB, Line Inputs Active	12	48	mV (max)
		$R_L = 4\Omega$, f = 1kHz			
		THD+N = 1%	1.9		W
D	Output Bower	THD+N = 10%	2.5		W
P _{OUT}	Output Power	$R_L = 8\Omega$, f = 1kHz			
		THD+N = 1%	1.25		mW (min)
		THD+N = 10%	1.54		W
		$P_0 = 635 \text{mW}, \text{ f} = 1 \text{ kHz}, \text{ R}_L = 8 \Omega$			
THD+N	Total Harmonic Distortion	DAC Active	0.06		%
		Line Inputs Active	0.04		%
		$V_{\text{RIPPLE}} = 200 \text{mV}_{\text{P-P}}, \text{ f} = 1 \text{kHz}$	3	•	
PSRR	Power Supply Poinction Datio	DAC Active, Internal Reference	60		dB
ronn	Power Supply Rejection Ratio	DAC Active, External Reference	60		dB
		Line Inputs Active	70		dB

			LM4	9450	
Sym 益 询	"LM49450"出版。	Conditions	Typical	Limit	Units
		The second se	(Note 6)	(Note 7)	– (Limits)
η	Efficiency	$P_0 = TBDmW, f = 1kHz$ $R_L = 8\Omega$	80		%
		$P_0 = 500 \text{mW}, \text{ f} = 1 \text{kHz}, \text{ R}_L = 8\Omega$			
N/1 11		DAC Active, Line Inputs Active	74 79		dB dB
Xtalk	Crosstalk	$P_0 = 500 \text{mW}, \text{ f} = 10 \text{kHz}, \text{ R}_L = 8\Omega$			
		DAC Active, Line Inputs Active	60 60		dB dB
		$P_0 = 500 \text{mW}, \text{ f} = 1 \text{kHz}, \text{ A-weighted}$			
SNR	Signal to Noise Ratio	DAC Active, Internal Reference	88		dB
Sinn		DAC Active, External Reference	89		dB
		Line Inputs Active	98		dB
•		Maximum Gain Setting, Line Inputs Active	24.2	22.5 24.2	dB (min) dB (max
A _V	Digitally Controlled Gain Level	Minimum Gain Setting, Line Inputs Active	-48	-49 -46	dB (min) dB (max
Mute	Mute Attenuation	Line Inputs Active	-92		dB
ΔA _{CH-CH}	Channel-to-Channel Gain Matching		0.3		dB
		Input Referred, A-weighted			
_	Output Naisa	DAC Active, Internal Reference	60		μV
ε _{OS}	Output Noise	DAC Active, External Reference	85		μV
		Line Inputs Active	40		μV
t _{ON}	Turn-On Time		27		ms
t _{OFF}	Turn-Off Time		1		ms

Timing Characteristics (Notes 2, 8) The following specifications apply for Headphone: $A_V = 0$ dB, $R_{L(LS)} = 8\Omega$, $R_{L(HP)} = 32\Omega$, f = 1kHz, unless otherwise specified. Limits apply for $T_A = 25^{\circ}$ C.

Symbol	Parameter	Conditions	LM49450		
			Typical	Limit	Units (Limits)
			(Note 6)	(Note 7)	(Linns)
AUDIO INTER	FACE TIMING				
t _{MCLKL}	MCLK Pulse Width Low			16	ns (min)
t _{MCLKH}	MCLK Pulse Width High			16	ns (min)
t _{MCLKY}	MCLK Period			32	ns (min)
t _{BCLKR}	BCLK Rise Time			3	ns (max)
t _{BCLKCF}	BCLK Fall Time			3	ns (max)
t _{BCLKDS}	BCLK Duty Cycle		50		%
t	LRC Propagation Delay from			10	ns (max)
t _{DL}	BCLK falling edge			10	
t _{DST}	DATA Setup Time to BCLK Rising Edge			10	ns (min)
	DATA Hold Time from BCLK			10	ns (min)
t _{DHT}	Rising Edge				
CONTROL IN	TERFACE TIMING		•		3
	SCLK Frequency			400	kHz (max)
1	Hold Time (repeated START			0.6	µs (min)
	Condition)				

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			LM49450		
查询 symbo 4945	0"供应商Parameter	Conditions	Typical	Limit	Units
			(Note 6)	(Note 7)	(Limits)
2	Clock Low Time			1.3	µs (min)
3	Clock High Time			600	ns (min)
4	Setup Time for a Repeated START Condition			600	ns (min)
	Data Hold Time	Output		300	ns (min)
5		Input		0 900	ns (min) ns (max)
6	Data Setup Time			100	ns (min)
7	Rise Time of SDA and SCL			20+0.1C _B 300	ns (min) ns (max)
8	Fall Time of SDA and SCL			15+0.1C _B 300	ns (min) ns (max)
9	Setup Time for STOP Condition			600	ns (min)
10	Bus Free time Between a STOP and START Condition			1.3	µs (min)
C _B	Bus Capacitance			10 200	pF (min) pF (max)

Note 1: "Absolute Maximum Ratings" indicate limits beyond which damage to the device may occur, including inoperability and degradation of device reliability and/or performance. Functional operation of the device and/or non-degradation at the Absolute Maximum Ratings or other conditions beyond those indicated in the Recommended Operating Conditions is not implied. The Recommended Operating Conditions indicate conditions at which the device is functional and the device should not be operated beyond such conditions. All voltages are measured with respect to the ground pin, unless otherwise specified

Note 2: The *Electrical Characteristics* tables list guaranteed specifications under the listed *Recommended Operating Conditions* except as otherwise modified or specified by the *Electrical Characteristics Conditions* and/or Notes. Typical specifications are estimations only and are not guaranteed.

Note 3: The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{JMAX} , θ_{JA} , and the ambient temperature, T_A . The maximum allowable power dissipation is $P_{DMAX} = (T_{JMAX} - T_A) / \theta_{JA}$ or the number given in *Absolute Maximum Ratings*, whichever is lower.

Note 4: Human body model, applicable std. JESD22-A114C.

Note 5: Machine model, applicable std. JESD22-A115-A.

Note 6: Typical values represent most likely parametric norms at T_A=+25°C, and at the Recommended Operation Conditions at the time of product characterization and are not guaranteed.

Note 7: Datasheet min/max specification limits are guaranteed by test or statistical analysis.

Note 8: RL is a resistive load in series with two inductors to simulate an actual speaker load. For $R_L = 8\Omega$, the load is $15\mu H + 8\Omega$, $+15\mu H$. For $RL = 4\Omega$, the load is $15\mu H + 4\Omega + 15\mu H$.

Pin Descriptions 查词"LM49450"供应商

TABLE 1.

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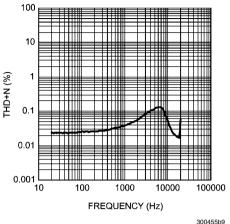
Pin	Name	Description	
1	C1P	Charge Pump Flying Capacitor Positive Terminal	
2	CPGND	Charge Pump Ground	
3	SDA	I ² C Serial Data Input	
4	DGND	Digital Ground	
5	I ² S_WS	I ² S Word Select Input	
6	I ² S_SDI	I ² S Serial Data Input	
7	I2S_CLK	I ² S Clock Input	
8	MCLK	Master Clock	
9	SCL	I2C Clock Input	
10	DV _{DD}	Digital Core Power Supply	
11	IOV _{DD}	Digital Interface Power Supply	
12	GND	Analog Ground	
13	REF	DAC Reference Bypass	
14	INR	Right Channel Analog Input	
15	INL	Left Channel Analog Input	
16	V _{DD}	Analog Power Supply	
17	BYPASS	Mid-Rail Bias Bypass	
18, 24	LSV _{DD}	Speaker Power Supply	
19	LLS+	Left Channel Non-Inverting Speaker Output	
20	LLS-	Left Channel Inverting Speaker Output	
21	LSGND	Speaker Ground	
22	RLS-	Right Channel Inverting Speaker Output	
23	RLS+	Right Channel Non-Inverting Speaker Output	
25	HPGND	Headphone Amplifier Ground	
26	HPS	Headphone Sense Input	
27	HPR	Right Channel Headphone Amplifier Output	
28	HPV _{DD}	Headphone Amplifier Power Supply	
29	HPL	Left Channel Headphone Amplifier Output	
30	HPV _{SS}	Charge Pump Output and Headphone Amplifier Negative Power Supply.	
31	C1N	Charge Pump Flying Capacitor Negative Terminal	
32	CPV _{DD}	Charge Pump Power Supply	



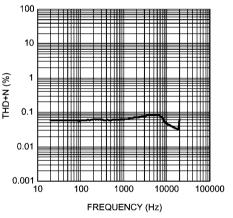
Typical Performance Characteristics 查询"LM49450"供应商 **THD+N vs Frequency** $V_{DD} = 3.0V, P_{OUT} = 50mW, R_L = 4\Omega$ DAC Input, Internal Reference, Speaker Mode 100 100 10 10 (%) N+DH (%) N+OH1 1 1 0.1 0.1 Ш 0.01 0.01 0.001 0.001 10 100 1000 10000 100000 FREQUENCY (Hz) 300455b6 **THD+N vs Frequency** $V_{DD} = 3.0V, P_{OUT} = 50mW, R_L = 4\Omega$ DAC Input, External Reference, Speaker Mode 100 100 10 10 (%) N+DH (%) N+OH1 1 1 0.1 0.1 0.01 0.01 0.001 0.001 10 100 1000 10000 100000 FREQUENCY (Hz) 300455c4 **THD+N vs Frequency** V_{DD} = 3.0V, P_{OUT} = 100mW, R_L = 4 Ω Analog Input, Speaker Mode 100 100 10 10 THD+N (%) THD+N (%) 1 • 0.1 0.1 0.01 0.01 0.001 0.001 10000 10 100 1000 100000 FREQUENCY (Hz)

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THD+N vs Frequency V_{DD} = 3.0V, P_{OUT} = 150mW, R_L = 8 Ω DAC Input, Internal Reference, Speaker Mode

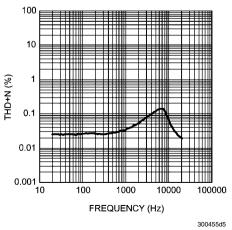


THD+N vs Frequency V_{DD} = 3.0V, P_{OUT} = 150mW, R_L = 8 Ω DAC Input, External Reference, Speaker Mode

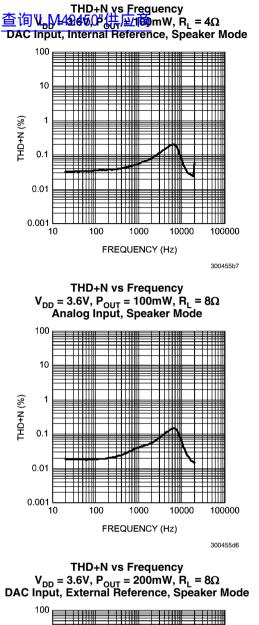


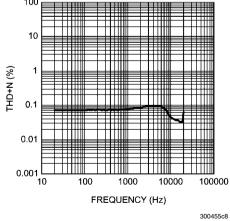


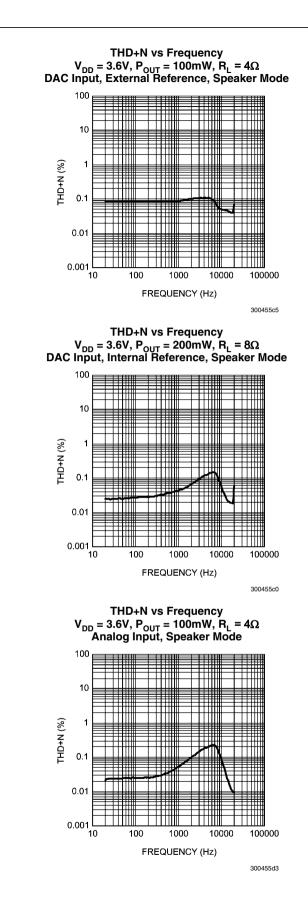
THD+N vs Frequency V_{DD} = 3.0V, P_{OUT} = 80mW, R_{L} = 8 Ω Analog Input, Speaker Mode



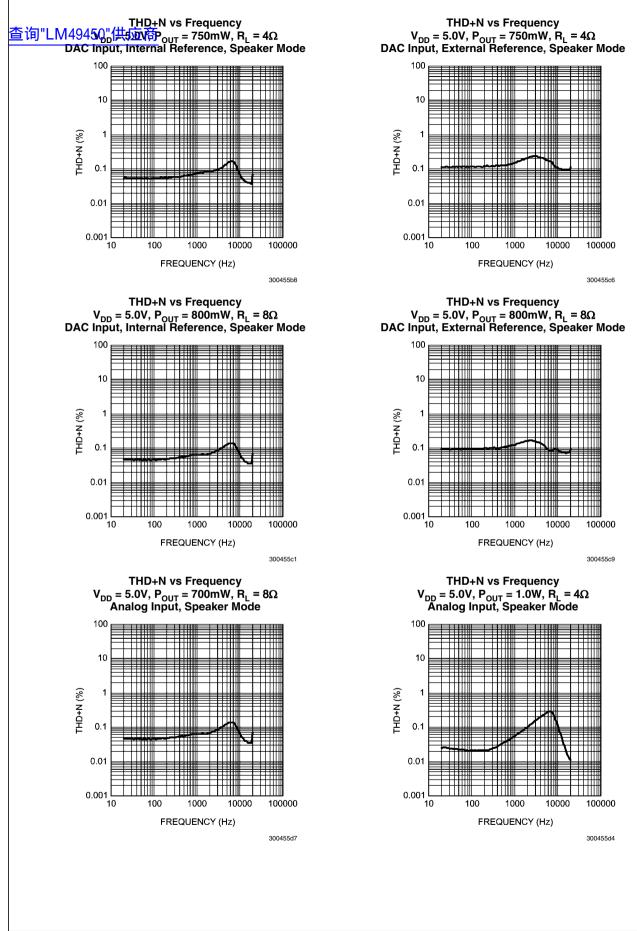


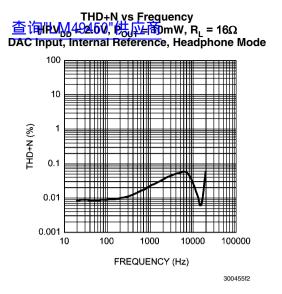


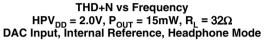


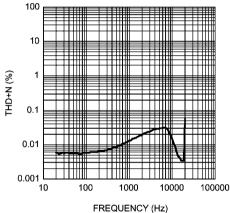




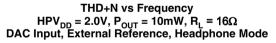


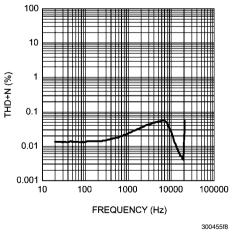


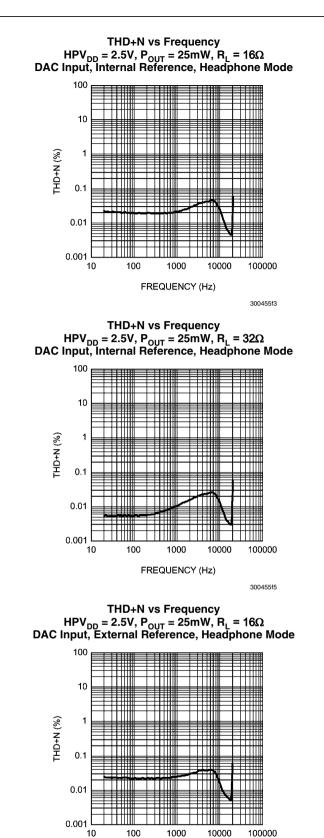




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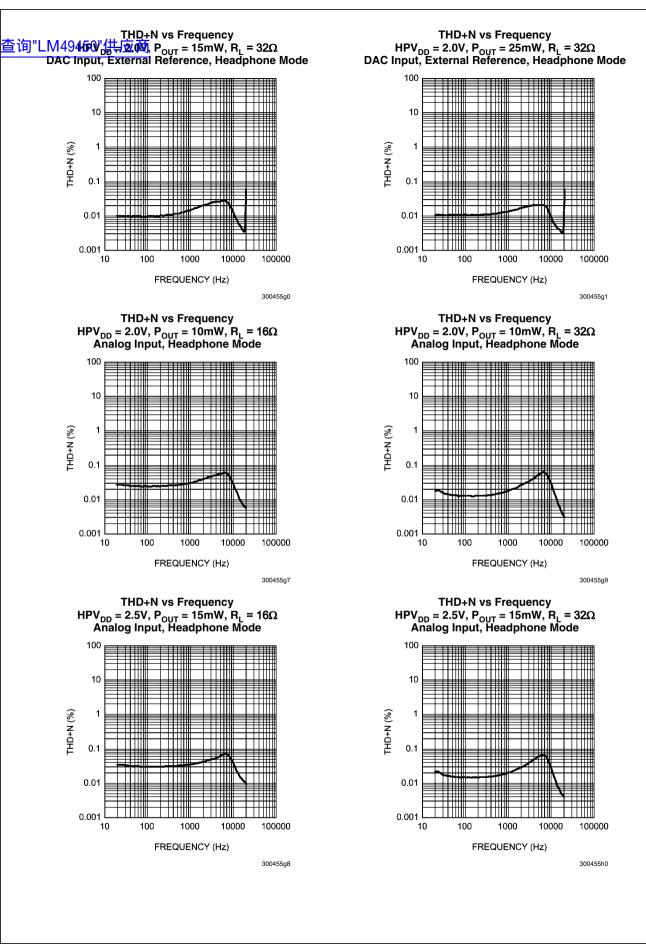


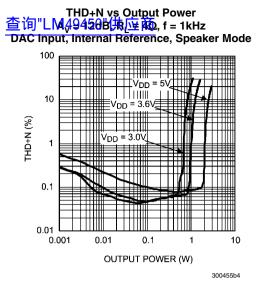


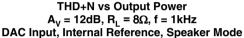
300455f9

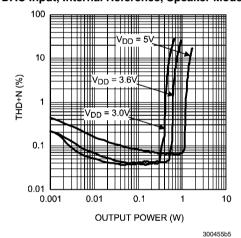
FREQUENCY (Hz)

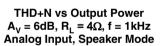


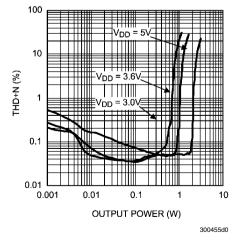


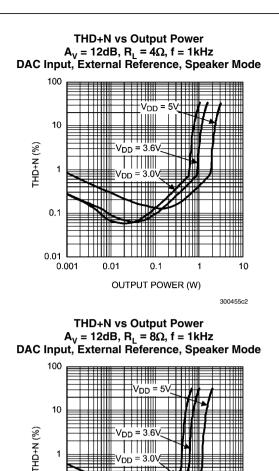












THD+N vs Output Power $A_V = 6dB, R_L = 8\Omega, f = 1kHz$ Analog Input, Speaker Mode

0.1

OUTPUT POWER (W)

10

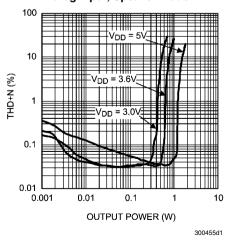
300455c3

0.01

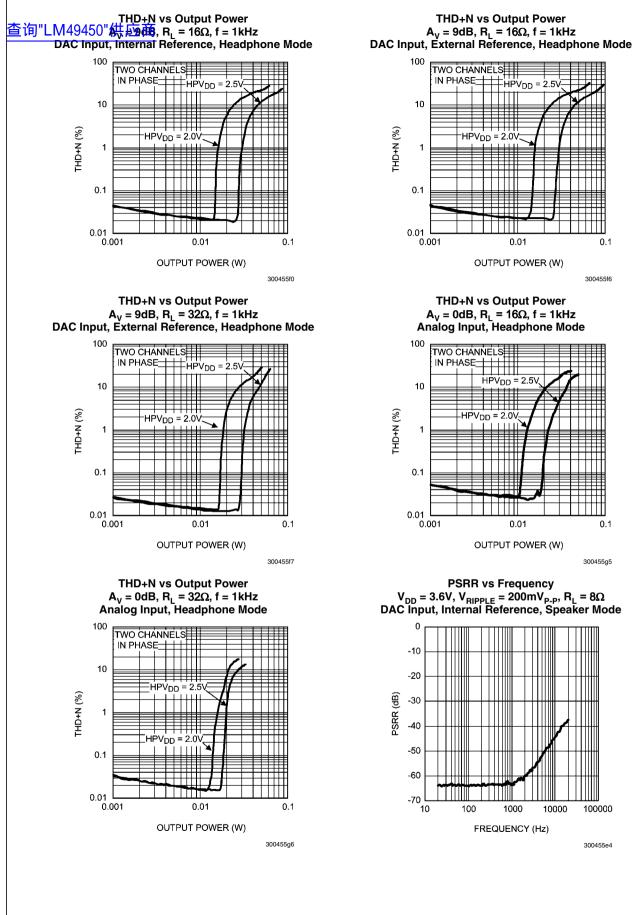
0.1

0.01

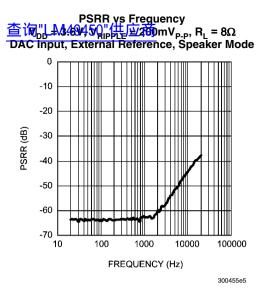
0.001

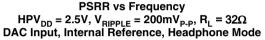


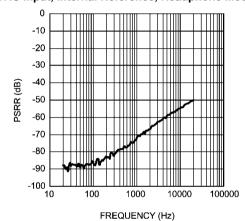




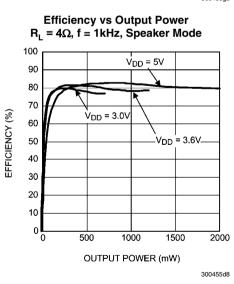


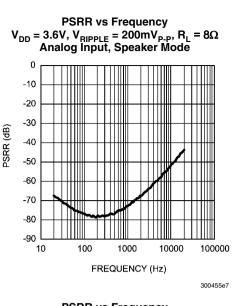




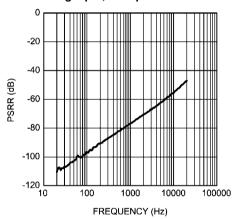






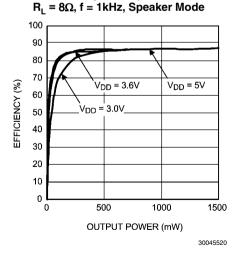


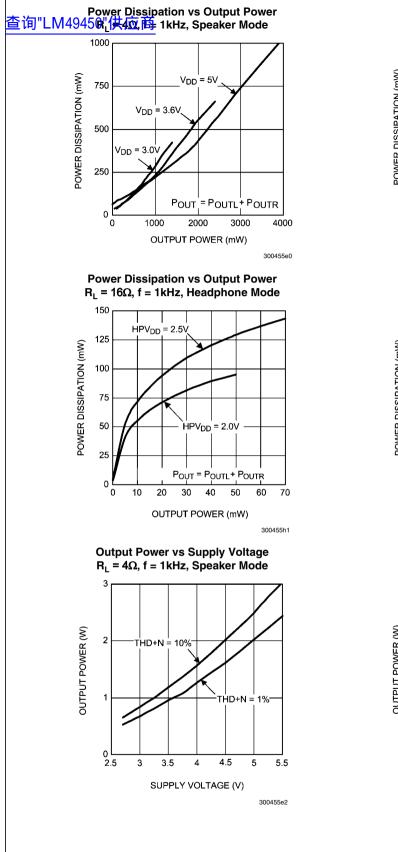
 $\begin{array}{l} \text{PSRR vs Frequency} \\ \text{HPV}_{\text{DD}} = 2.5 \text{V}, \, \text{V}_{\text{RIPPLE}} = 200 \text{mV}_{\text{P-P}}, \, \text{R}_{\text{L}} = 32 \Omega \\ \text{Analog Input, Headphone Mode} \end{array}$

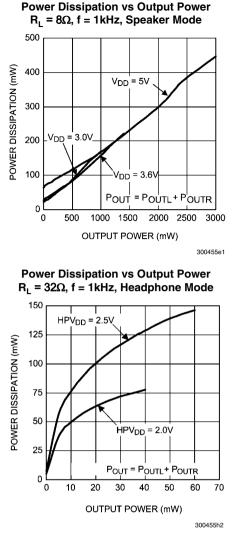


300455h5

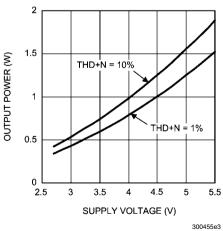
Efficiency vs Output Power







Output Power vs Supply Voltage $R_L = 8\Omega$, f = 1kHz, Speaker Mode



LM49450



2.4

10000

10000

100000

300455h6

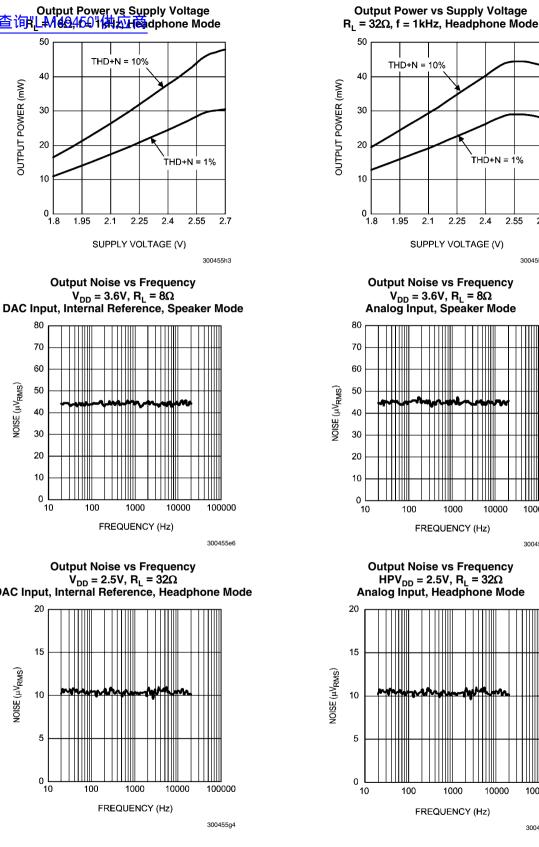
100000

300455e8

2.55

2.7

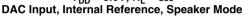
300455h4

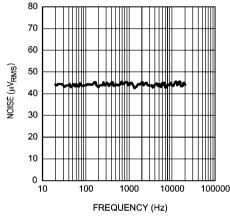


50 THD+N = 10% 40 OUTPUT POWER (mW) 30 20 10

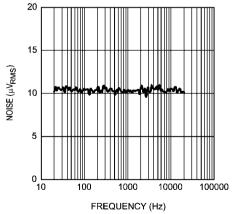
0 ∟ 1.8

1.95 2.1 SUPPLY VOLTAGE (V) **Output Noise vs Frequency**

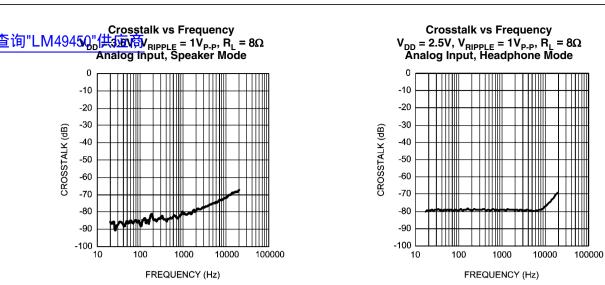




Output Noise vs Frequency $V_{DD} = 2.5V, R_{L} = 32\Omega$ DAC Input, Internal Reference, Headphone Mode







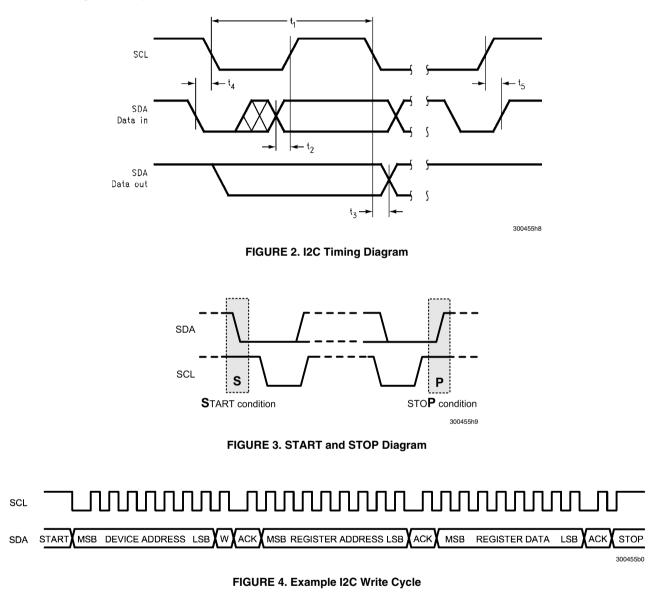
300455e9

300455h7

Application Information I2C COMPATIBLE INTERFACE/商

The LM49450 is controlled through an I²C compatible serial interface that consists of a serial data line (SDA) and a serial clock (SCL). The clock line is uni-directional. The data line is bi-directional (open collector). The LM49450 and the master can communicate at clock rates up to 400kHz. Figure 2 shows the I²C interface timing diagram. Data on the SDA line must be stable during the HIGH period of SCL. The LM49450 is a

transmit/receive slave-only device, reliant upon the master to generate the SCL signal. Each transmission sequence is framed by a START condition and a STOP condition (Figure 3). Each data word, register address and register data, transmitted over the bus is 8 bits long as is always followed by and acknowledge pulse (Figure 3). The LM49450 device address is 1111101.



BUS FORMAT

The I²C bus format is shown in Figure 4. The START signal, the transition of SDA from HIGH to LOW while SDA is HIGH, is generated, altering all devices on the bus that a device address is being written to the bus.

The 7-bit device address is written to the bus, most significant bit (MSB) first, followed by the R/\overline{W} bit ($R/\overline{W} = 0$ indicates the master is writing to the LM49450, $R/\overline{W} = 1$ indicates the master wants to read data from the LM49450). The data is latched in on the rising edge of the clock. Each address bit must be stable while SDA is HIGH. After the last address bit is trans-

mitted, the master device releases SDA, during which time, an acknowledge clock pulse is generated by the slave device. If the LM49450 receives the correct address, the device pulls the SDA line low, generating and acknowledge bit (ACK).

Once the master device registers the ACK bit, the 8-bit register address word is sent. Each data bit should be stable while SCL is HIGH. After the 8-bit register address is sent, the LM49450 sends another ACK bit. Following the acknowledgement of the register address, the 8-bit register data word is sent. Each data bit should be stable while SCL is HIGH. After the 8-bit register data is sent, the LM49450 sends another ACK

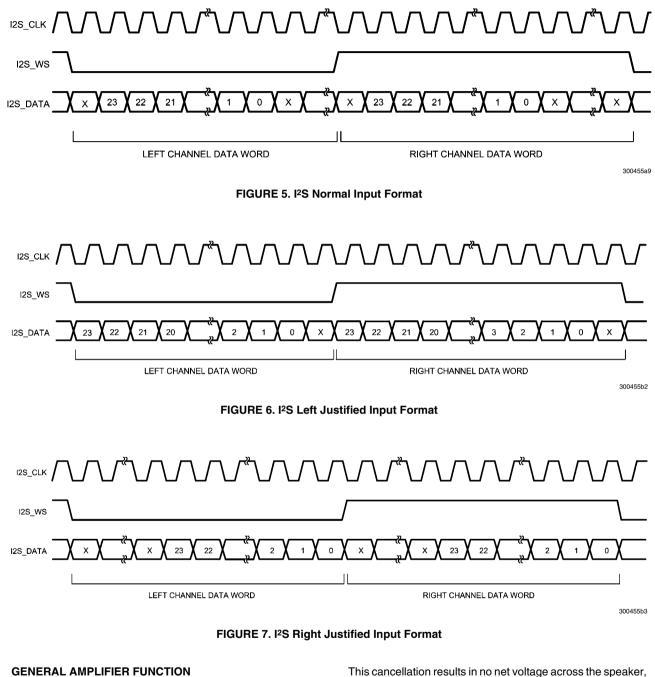
_M49450

other ACK bit. Following the acknowledgement of the register

I²S DATA FORMAT

The LM49450 supports three I²S formats: Normal Mode (Figure 5), Left Justified Mode (Figure 6), and Right Justified

Mode (Figure 7). In Normal Mode, the audio data is transmitted MSB first, with the unused bits following the LSB. In Left Justified Mode, the audio data format is similar to the Normal Mode, without the delay between the LSB and the change in I²S_WS. In Right Justified Mode, the audio data MSB is transmitted after a delay of a preset number of bits.



Class D Amplifier

The LM49450 features a high-efficiency stereo Class D audio power amplifier that utilizes National's filterless modulation scheme which reduces external component count, conserves board space and reduces system cost. The Class D outputs transition between V_{DD} and GND with a 300kHz switching frequency. With no signal applied, the outputs switch with a 50% duty cycle, in phase, causing the two outputs to cancel.

This cancellation results in no net voltage across the speaker, thus there is no current to the load in the idle state.

With the input signal applied, the duty cycle (pulse width) of the LM49450 outputs changes. For increasing output voltage, the duty cycle of V_LS+ increases while the duty cycle of V_LS- decreases. For decreasing output voltages, the converse occurs. The difference between the two pulse widths yield the differential output voltage.

Fixed Frequency Mode

Spread Spectrum

The logic selectable spread spectrum mode eliminates the need for output filters, ferrite beads or chokes. In spread spectrum mode, the switching frequency varies randomly by 30% about a 300kHz center frequency, reducing the wideband spectral content, improving EMI emissions radiated by the speaker and associated cables and traces. Where a fixed frequency class D exhibits large amounts of spectral energy at multiples of the switching frequency, the spread spectrum architecture of the LM49450 spreads that energy over a larger bandwidth (see Typical Performance Characteristics). The cycle-to-cycle variation of the switching period does not affect the audio reproduction, efficiency, or PSRR. Set the SS bit (B3) in the Mode Control Register (0x00h) to 1 to select spread spectrum mode.

Headphone Amplifier

The LM49450 headphone amplifiers feature National's ground referenced architecture that eliminates the large DCblocking capacitors required at the outputs of traditional headphone amplifiers. A low-noise inverting charge pump creates a negative supply (HPV_{SS}) from the positive supply voltage (CPV_{DD}). The headphone amplifiers operate from these bipolar supplies, with the amplifier outputs biased about GND, instead of a nominal DC voltage (typically V_{DD}/2), like traditional amplifiers. Because there is no DC component to the headphone output signals, the large DC-blocking capacitors (typically 220µF) are not necessary, conserving board space and system cost, while improving frequency response.

Power Supplies

The LM49450 uses different power supplies for each portion of the device, allowing for the optimum combination of headroom, power dissipation and noise immunity. The analog input, and gain (volume control) stages for both speaker and headphones are powered from V_{DD} . The speaker output stage is powered from LSV_{DD}. The headphone amplifiers and charge pump are powered from HPV_{DD}. The separate power supplies allow the class D amplifiers to operate from a higher voltage, maximizing headroom, while the headphones operate from a lower voltage, improving power dissipation, as well as minimizing switching noise coupling between the speaker and headphone amplifiers. The digital portion of the device is powered from DV_{DD}, including the 3D processing core and DAC. IOV_{DD} powers the I2S and I2C, allowing the LM49450 to interface with lower voltage digital controllers.

National's 3D Enhancement

The LM49450 digital audio path features National's 3D enhancement that widens or narrows the perceived soundstage of a stereo audio signal. The 3D enhancement either increases or decreases the apparent stereo channel separation, improving audio reproduction whenever the placement of both left and right speakers is not ideal.

The LM49450 3D function is controlled through the I²C interface. The headphone and speakers have independent 3D controls, allowing each signal path to have its own individual 3D configuration. The LM49450 3D features two effect modes, a narrow effect that decreases the channel separation, making the speakers sound closer together, and a wide effect that makes the speakers sound farther apart. Because the narrow effect mode adds a portion of the left and right signals together, a selectable 6dB attenuation mode is provided to maintain a constant output amplitude when the narrow effect mode is active without changing the volume level. The high pass 3dB roll off frequency, 3D gain (amount channel mixing), and narrow/wide effect selection is done through registers 0x05h (headphone) and 0x06h (speaker. See the *Headphone 3D Configuration Register* and *Loudspeaker 3D Control Register* sections for more information.

Headphone Sense

The LM49450 features a headphone sense input (HPS) that monitors the headphone jack and configures the device depending on the presence of a headphone. When the HPS pin is low, indicating that a headphone is not present, the LM49450 speaker amplifiers are active and the headphone amplifiers are disabled. When the HPS pin is high, indicating that a headphone is present, the headphone amplifiers are active while the speaker amplifiers are disabled.

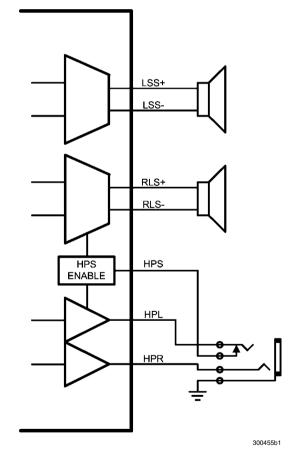


FIGURE 8. HPS Connection

Volume Control

The LM49450 features two separate 32-step volume controls, one for the speaker channels and one for the headphone channels. This allows for the gain of the headphone and speakers to be set independently of each other.

External Reference

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Low Power Shutdown

The LM49450 features an I²C selectable low power shutdown mode that disables the entire device, reducing quiescent current consumption to 0.05μ A (digital + analog current). Set bit B0 in the mode control register (0x00h) to 0 to disable the device. Set B0 to 1 to enable the device.

I2S CLOCK CONTROL

The LM49450 features the ability to derive multiple clock signals, including the DAC clock, I²S clock and word select clock in master mode, and the charge pump oscillator frequency, from the MCLK input.

DAC Clock Divider (RDIV)

Bits B5-B0 in the CLOCK CONTROL register (0x01h) are the RDIV bits that set the DAC clock divider ratio. The DAC clock derived from MCLK needs to match the DAC sampling rate. For example, with f_{MCLK} = 12.288MHz and a 64*f_S oversam-

pling ratio (f_S = 48kHz), the DAC requires a 6.144MHz clock. In this case, set the RDIV ratio to divide by 2. In other instances, there may not be a suitable divider ratio for a given sampling rate and MCLK frequency. In this case, f_{MCLK} may need to be altered. See the *Clock Control Register* section for more information.

I²S WS Clock Dividers (I2S_CLK, WS_CLK)

In I²S master mode, the LM49450 I2S CLOCK CONTROL register (0x04h) can be used to set the I²S clock and WS clock frequency. In I2S clock master mode, bits B7-B4 of the I2S CLOCK CONTROL register, the I2S_CLK bits, set the I²S clock divider ratio. The LM49450 derives the I²S clock from DAC clock based on the ratio set by the I2S_CLK bits. The I²S clock is output on I²S_CLK.

In I²S master mode, bits B3 and B2 (I2S_WS) of the I2S CLOCK CONTROL register set the bit length per data word of the I²S WS.

Charge Pump Clock Divider (CPDIV)

The ground referenced headphone amplifiers charge pump derives its clock from MCLK. Bits B7-B0 of the CHARGE PUMP CLOCK register (0x02h) set the charge pump clock divider ratio. See the *Charge Pump Clock Register* section for more information.

	查 B0	间			I2S_MOMT0	I2S_CLK_MS	HP_3DEN	LS_3DEN	HPO	LS0	$C0_0$	C0_08	C1_0	C1_08	$C2_0$	C2_08
	B1		RDIV_1	CPDIV_1	12S_MODE_1_ 128	12S_WS_MS 128	HP_3D_MODE H	LS_3D_MODE 1	HP1	LS1	C0_1	C0_09	C1_1	C1_09	C2_1	C2_09
	B2	MUTE	RDIV_2	CPDIV_2	I2S_WORD _ORDER	I2S_WS_0	HP_3D_GAIN_0	LS_3DGAIN_0	HP2	LS2	C0_2	C0_10	C1_2	C1_10	C2_2	C2_10
ap	B3	SS		CPDIV_3	12S STEREO REVERSE	I2S_WS_1	HP_3D_GAIN_1	LS_3DGAIN_1	HP3	ES1	€_03	C0_111	C1_3	C1_11	$C2_3$	C2_11
:RS — Register M	B4	COMP	RDIV_4	CPDIV_4	I2S_WRD_0	I2S_CLK_0	HP_3DFREQ_0	LS_3DFREQ_0	HP4	LS4	$C0_4$	C0_12	C1_4	C1_12	C2_4	C2_12
CONTROL REGISTERS — Register Map	B5	DAC_MODE_ 0	RDIV_5	CPDIV_5	I2S_WRD_1	I2S_CLK_1	HP_3DFREQ_1	LS_3DFREQ_1	RESERVED	RESERVED	$C0_5$	C0_13	C1_5	C1_13	C2_5	C2_13
CC	B6	DAC_MODE_1	DAC_DITHER _ON	CPDIV_6	I2S_WRD_2	I2S_CLK_2	HP_3DATTN	LS_3DATTN	RESERVED	RESERVED	$C0_6$	C0_14	C1_6	C1_14	$C2_6$	C2_14
	B7	EXT_REF	DAC_DITHER _OFF	CPDIV_7	RESERVED	I2S_CLK_3	RESERVED	RESERVED	RESERVED	RESERVED	C0_7	C0_15	C1_7	C1_15	C2_7	C2_15
	Register Name	MODE CONTROL	CLOCK	CHARGE PUMP CLOCK FREQUENCY	I2S MODE	I2S CLOCK	HEADPHONE 3D CONTROL	SPEAKER 3D CONTROL	HEADPHONE VOLUME CONTROL	SPEAKER VOLUME CONTROL	CMP_0_LSB	CMP_0_MSB	CMP_1_LSB	CMP_1_MSB	CMP_2_LSB	CMP_2_MSB
	Register Addess	400x0	0x01h	0x02h	0x03h	0x04h	0x05h	0x06h	0x07h	0x08h	0×09h	0x0Ah	0x0Bh	0x0Ch	0x0Dh	0x0Eh

LM49450

TABLE 2. Mode Control Register

Bit	Name	Value		Description		
			0	Internal reference selected		
B7	EXT_REF		1	External reference selected. See External Reference section.		
		B6	B5	Select DAC over sampling Rate		
		0	0	125		
B6:B5	DAC_MODE_1 (B6)	0	1	128		
		1	0	64		
		1	1	32		
			0	Default DAC compensation filter selected		
B4	COMP		1	Programmable DAC compensation filter selected. See DAC Compensation Filter section.		
Do	00		0	Fixed frequency oscillator selected		
B3	SS		1	Spread spectrum oscillator selected		
B2			0	Un-mute device		
B2	MUTE		1	Mute device		
B0	ENABLE	0		Device shutdown. Default state during a POR event		
BU	CINABLE		1	Device enabled.		

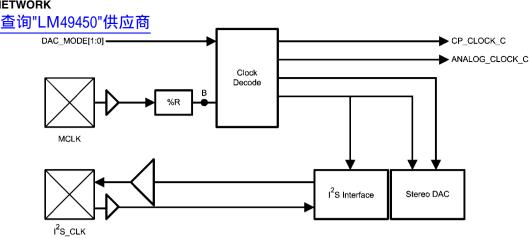
CLOCK CONTROL REGISTER (0x01h)

Default value is 0x00h.

TABLE 3. Clock Control Register

Bit	Name	Value						Description
B7	DAC_DITHER_OFF	(0					Default DAC state
D/	DAC_DITHER_OFF		1					Permanently disables DAC dither
B6		(C					Default DAC state
DO	DAC_DITHER_ON		1					Permanently enables DAC dither
		B5	B4	B3	B2	B1	B0	Sets MCLK divider ratio
		0	0	0	0	0	0	Bypass divider
		0	0	0	0	0	1	1
	RDIV_5 (B5)	0	0	0	0	1	0	1.5
	RDIV_4 (B4)	0	0	0	0	1	1	2
B5:B0	RDIV_3 (B3) RDIV_2 (B2)	0	0	0	1	0	0	2.5
	RDIV_2 (B2)	0	0	0	1	0	1	5
	RDIV_0 (B0)			Т	0	•		In 0.5 increments
	/	1	1	1	1	0	1	31
		1	1	1	1	1	0	31.5
		1	1	1	1	1	1	32

CLK NETWORK



LM49450 Clock Structure

CLK Network Diagram

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LM49450

The MCLK input is first divided by the R divider to product the clock at point B; this is then decoded according to the DAC_MODE to produce a signal which goes to both the DAC digital and the I2S interface, and a signal which goes to the DAC analog.

This table describes the relationship between the clocks, for each of the four possible DAC modes in terms of audio input sampling frequency fs.

TABLE 4. Relationship between clocks for each of the four DAC modes

DAC MODE	Description						
	OSR	CLK at B	DAC Digital CLK	DAC Analog CLK			
00	125	250fs	250fs	125fs			
01	128	256fs	128fs	128fs			
10	64	128fs	128fs	64fs			
11	32	128fs	128fs	32fs			

Common Clock Settings for the DAC

In DAC_MODE 0, the DAC has an oversampling rate (OSR) of 125 but requires a 250xfs clock at point B. This allows a simple clocking solution as it will work from 12.000MHz (common in most systems with Bluetooth or USB) at 48kHz exact-

ly. In the other DAC modes, the DAC requires a conventional 2^Nxfs clock for conversation. The following table describes the clock required at point B for various clock sample rates in the different DAC modes:

TABLE 5. Common DAC Clock Frequencies

Sample Rate	Clock Required at B (MHz)							
	DAC MODE = 2b00	DAC MODE = 2b01 (OSR	DAC MODE = 2b10	DAC MODE = 2b11				
	(OSR = 125fs, Clock	= 128fs, Clock Required =	(OSR = 64fs, Clock	(OSR = 32fs, Clock				
	Required = 250fs)	256fs)	Required = 128fs)	Required = 128fs)				
8	2	2.084	—	—				
11.025	2.75625	2.8224	—	_				
12	3	3.072	—	_				
16	4	4.096	_	_				
22.05	5.5125	5.6448	_	_				
24	6	6.144	_	_				
32	8	8.192	_	_				
44.1	11.025	11.2896	_	_				
48	_	12.288	_	_				
88.2	_	—	11.2896	_				
96	_	_	12.288	_				
176.4	_	_	_	22.5792				
192	_	_	_	24.576				

CHARGE PUMP CLOCK REGISTER (0x02h)

Bit	Name				Va	lue				Description
	CPDIV_7 (B7) CPDIV_6	B7	B6	B5	B4	B3	B2	B1	B0	Sets charge pump oscillator frequency in DAC mode (derived from MCLK).
	(B6)	0	0	0	0	0	0	0	0	Bypass divider
	CPDIV_5	0	0	0	0	0	0	0	1	1
	(B5) CPDIV_4 (B4)	0	0	0	0	0	0	1	0	1.5
		0	0	0	0	0	0	1	1	2
B7:B0	CPDIV_3	0	0	0	0	0	1	0	0	2.5
	(B3)	0	0	0	0	0	1	0	1	3
	CPDIV_2			Т	0					In 0.5 increments
	(B2) CPDIV_1 (B1) CPDIV_0 (B0)	1	1	1	1	1	1	0	1	127
		1	1	1	1	1	1	1	0	127.5
		1	1	1	1	1	1	1	1	128

TABLE 6. Charge Pump Clock Register

CP_DIV REGISTER

LM49450 Clock Structure

When the register field LINE_IN_ENABLE is high, the Clocks module is held in reset and as a result no CP_CLOCK_C is produced.

This register is used to control the charge pump clock when the register field LINE_IN_ENABLE is low i.e. DAC mode.

TABLE 7. CP_DIV Default Value 0x49h

Bits	Field	Description						
7:0	CP_DIV	Programs the CP divider (devides from an expected 12.000MH: input).						
		CP_DIV	Divide Value					
		0	Bypass					
		1	1					
		2	1.5					
		3	2					
		4	2.5					
		5 to 253	3 to 127					
		254	127.5					
		255	128					

Examples of CP_DIV Values one might use for various sample rates and DAC modes

TABLE 8. Typical CP_DIV Values for DAC Mode 00

MCLK (MHZ)	CP_DIV	Nominal Frequency (Hz)
2	11	333333
2.75625	16	324265
3	17	333333
4	23	333333
5.5125	33	324264
6	36	324324
8	48	326530

MCLK (MHZ)	CP_DIV	Nominal Frequency (Hz)
查询"LM49450"供应商	67	324265
12	73	324324

TABLE 9. Typical CP_DIV Values for DAC Mode 01

MCLK (MHZ)	CP_DIV	Nominal Frequency (Hz)
2.048	11	341333
2.8224	17	313600
3.072	18	323368
4.096	24	327680
5.6448	33	332047
6.144	37	323368
8.192	49	327680
11.2896	68	327234
12.288	75	323368

TABLE 10. Typical CP_DIV Values for DAC Mode 10

MCLK (MHZ)	CP_DIV	Nominal Frequency (Hz)
11.2896	68	327234
12.288	75	323368

TABLE 11. Typical CP_DIV Values for DAC Mode 11

MCLK (MHZ)	CP_DIV	Nominal Frequency (Hz)
22.5792	138	324881
24.576	150	325510

I2S MODE CONTROL REGISTER (0x03h)

Default value is 0x00h.

TABLE 12. I2S Mode Control Register

Bit	Name	Value			Description
B7	RESERVED		Х		Unused
		B6	B5	B4	Sets I ² S word size in Right Justified Mode
		0	0	0	16
		0	0	1	18
	I2S_WRD_2 (B6)	0	1	0	20
B6:B4	I2S_WRD_1 (B5)	0	1	1	22
	I2S_WRD_0 (B5)	1	0	0	24
		1	0	1	25
		1	1	0	26
		1	1	1	32
Do	I2S_STEREO	0			Normal mode. Left channel data goes to left channel output Right channel data goes to right channel output.
B3	_REVERSE	1			Reverse mode. Left channel data goes to right channel output Right channel data goes to left channel output

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Bit	Name		Value	Description
查 询"LM 4945	0"供应商			Normal mode.
			0	I ² S_WS = 0 indicates left channel audio
B2	I2S_WORD_ORD	1		I ² S_WS = 1 indicates right channel audio
	ER			Reverse mode.
				I ² S_WS = 0 indicates right channel audio
				I ² S_WS = 1 indicates left channel audio.
		B1	B0	Sets I ² S operating mode
		0	0	Normal Mode
B1:B0	I2S_MODE_1 (B1) I2S_MODE_0 (B0)	0	1	Left Justified Mode
	20_000	1	0	Right Justified Mode
		1	1	Unused

I2S CLOCK REGISTER (0x04h)

Default value is 0x00h.

TABLE 13. I2S Clock Register

Bit	Name		Va	lue		Desc	ription	
						Sets divider ratio to derive the I2S clock from the divided MCLK		
		B7	B6	B5	B4	I ² S master mode		
						DIVIDE BY	RATIO	
	-	0	0	0	0	1	—	
		0	0	0	1	2	_	
		0	0	1	0	4	—	
	I2S_CLK_3	0	1	1	1	6	—	
	(B7)	0	0	0	0	8	—	
	I2S_CLK_2	0	0	1	1	10	—	
B7:B4	(B6) I2S_CLK_1	0	1	0	0	16	—	
	(B5)	0	1	1	1	20	_	
	12S_CLK_0	1	0	0	0	2.5	2.5	
	(B4)	1	0	0	1	3	1:3	
		1	0	1	0	3.90625	32:125	
		1	0	1	1	5	1:5	
		1	1	0	0	7.8125	16:125	
		1	1	0	1	_	_	
		1	1	1	0	_	_	
		1	1	1	1	_	—	
	12S_WS_1	B3 B2		32	Determines the bit length per data word of I ² S_WS in I ² S master mode			
B3:B2	(B3)	0			0	16		
B3:B2	12S_WS_0		0 1		1	25		
	(B2)		1 0		0	32		
			1 1					
	I2S_WS_M	0				I ² S WS slave mode. The LM49450 drives the I ² S WS signal from the I2S_WS line.		
B1	S	1				I ² S WS master mode. The LM49450 generates the I2S WS signal. I2S_WS line is driven by the LM49450		
Dâ	I2S_CLK_		()		I ² S clock slave mode. The LM49450 derives its I ² S clock from the I2S_CLK line.		
B0	MS		-	1		I ² S clock master mode. The LM49450 generates the I ² S clock signal. I2S_CLK line is driven by the LM49450.		

HEADPHONE 3D CONFIGURATION REGISTER (0x05h) Defaul 塗姆"追附仰450"供应商

Bit	Name	Value		Description	
B7	RESERVED		Х	UNUSED	
B6			0	No Attenuation	
DO	HP_3DATTN		1	Output signals are attenuated by 6dB	
		B5	B4	Sets 3D high pass filter -3dB (roll-off) frequency	
		0	0	0	
B5:B4	HP_3DFREQ_1 (B5) HP_3DFREQ_0 (B4)	0	1	300Hz	
		1	0	600Hz	
		1	1	900Hz	
		B3	B2	Sets the 3D mix level, ie the amount of the left channel signal that appears on the right channel and visa versa.	
	HP_3DFREQ_1 (B3)	0	0	25%	
B3:B2	HP_3DFREQ_0 (B2)	0	1	37.5%	
		1	0	50%	
		1	1	75%	
D1			0	Narrow 3D effect	
B1	HP_3D	1		Wide 3D effect	
BO		0		Headphone 3D disabled	
B0	HP_3DEN	1		Headphone 3D enabled	

LOUDSPEAKER 3D CONFIGURATION REGISTER (0x06h)

Default value is 0x00h.

TABLE 15. Loudspeaker 3D Configuration Register

Bit	Name	Value		Description	
B7	RESERVED		Х	UNUSED	
DC			0	No Attenuation	
B6	LS_3DATTN		1	Output signals are attenuated by 6dB	
		B5	B4	Sets 3D high pass filter -3dB (roll-off) frequency	
		0	0	0	
B5:B4	LS_3DFREQ_1 (B5) LS_3DFREQ_0 (B4)	0	1	300Hz	
	LO_00 (D4)	1	0	600Hz	
		1 1		900Hz	
		B3	B2	Sets the 3D mix level, ie the amount of the left channel signal that appears on the right channel and visa versa.	
	LS_3DFREQ_1 (B3)	0	0	25%	
B3:B2	LS_3DFREQ_0 (B2)	0	1	37.5%	
		1	0	50%	
		1 0		75%	
D1		-		Narrow 3D effect	
B1	HP_3D			Wide 3D effect	
Do			0	Loudspeaker 3D disabled	
B0	HP_3DEN	1		Loudspeaker 3D enabled	

HEADPHONE VOLUME CONTROL REGISTER (0x07h) 查爾啦帕/帕姆的的姓应商

Bit	Name	Value	Description
B7:B5	RESERVED	Х	UNUSED
B4:B0	HP4 (B4) HP3 (B3) HP2 (B2) HP1 (B1) HP0 (B0)	See Headphone Volume Control Table	Controls gain/attenuation of the audio signal in the headphone path.

VOLUME STEP	HP4	НРЗ	HP2	HP1	HP0	HP GAIN (dB)
1	0	0	0	0	0	-59
2	0	0	0	0	1	-48
3	0	0	0	1	0	-40.5
4	0	0	0	1	1	-34.5
5	0	0	1	0	0	-30
6	0	0	1	0	1	-27
7	0	0	1	1	0	-24
8	0	0	1	1	1	-21
9	0	1	0	0	0	-18
10	0	1	0	0	1	-15
11	0	1	0	1	0	-13.5
12	0	1	0	1	1	-12
13	0	1	1	0	0	-10.5
14	0	1	1	0	1	-9
15	0	1	1	1	0	-7.5
16	0	1	1	1	1	-6
17	1	0	0	0	0	-4.5
18	1	0	0	0	1	-3
19	1	0	0	1	0	-1.5
20	1	0	0	1	1	0
21	1	0	1	0	0	1.5
22	1	0	1	0	1	3
23	1	0	1	1	0	4.5
24	1	0	1	1	1	6
25	1	1	0	0	0	7.5
26	1	1	0	0	1	9
27	1	1	0	1	0	10.5
28	1	1	0	1	1	12
29	1	1	1	0	0	13.5
30	1	1	1	0	1	15
31	1	1	1	1	0	16.5
32	1	1	1	1	1	18

LOUDSPEAKER VOLUME CONTROL REGISTER (0x08h) Defaul'瑬姆"追M490450"供应商

TABLE 17.	Loudspeaker	Volume Control	l Reaister
	Louuspeaker		inegister

Bit	Name		Value		Description		
B7:B5	RESERVED		Х		UNUSED		
B4:B0	LS4 (B4) LS3 (B3) LS2 (B2) LS1 (B1) LS0 (B0)	See Loudsp Control Tab	eaker Volum le	e	Controls gain/attenuation of the audio signal in loudspeaker path.		nuation of the audio signal in the
VOLUMI STEP	E LS4	LS3	LS2	LS	51	LS0	LS GAIN (dB)
1	0	0	0	0		0	-53
2	0	0	0	0		1	-42
3	0	0	0	1		0	-34.5
4	0	0	0	1		1	-28.5
5	0	0	1	0		0	-24
6	0	0	1	0		1	-21
7	0	0	1	1		0	-18
8	0	0	1	1		1	–15
9	0	1	0	0		0	-12
10	0	1	0	0		1	-9
11	0	1	0	1		0	-7.5
12	0	1	0	1		1	-6
13	0	1	1	0		0	-4.5
14	0	1	1	0		1	-3
15	0	1	1	1		0	-1.5
16	0	1	1	1		1	0
17	1	0	0	0		0	1.5
18	1	0	0	0		1	3
19	1	0	0	1		0	4.5
20	1	0	0	1		1	6
21	1	0	1	0		0	7.5
22	1	0	1	0		1	9
23	1	0	1	1		0	10.5
24	1	0	1	1		1	12
25	1	1	0	0		0	13.5
26	1	1	0	0		1	15
27	1	1	0	1		0	16.5
28	1	1	0	1		1	18
29	1	1	1	0		0	19.5
30	1	1	1	0		1	21
31	1	1	1	1		0	22.5
32	1	1	1	1		1	24

DAC Compensation Filter

The LM49450 DAC features a 5 band FIR filter that can be used as an equalizer for the digital audio path. Registers 0x09h, 0x0Ah, 0x0Bh, 0x0Ch, 0x0Dh, and 0x0Eh provide an 8-bit control for each individual FIR filter.

EXTERNAL COMPONENT SELECTION

The LM49450 uses different supplies for each portion of the device, allowing for the optimum combination of headroom, power dissipation and noise immunity. The speaker amplifier gain stage is powered from V_{DD} , while the output stage is powered from LSV_{DD}. The headphone amplifiers, input amplifiers and volume control stages are powered from HPV_{DD}. The separate power supplies allow the speakers to operate from a higher voltage for maximum headroom, while the headphones operate from a lower voltage, improving power dissipation. HPV_{DD} may be driven by a linear regulator to further improve performance in noisy environments. The I²C portion of the LM49450 to interface with lower voltage digital controllers.

PROPER SELECTION OF EXTERNAL COMPONENTS

Power Supply Bypassing and Filtering

Proper power supply bypassing is critical for low noise performance and high PSRR. Place the supply bypass capacitors as close to the device as possible. Typical applications employ a voltage regulator with 10μ F and 0.1μ F bypass capacitors that increase supply stability. These capacitors do not eliminate the need for bypassing of the LM49450 supply pins. A 1μ F ceramic capacitor placed close to each supply pin is recommended.

Bypass Capacitor Selection

The LM49450 internally generates a $V_{DD}/2$ common-mode bias voltage. The BYPASS capacitor CBYPASS, improves PSRR and THD+N by reducing noise at the BYPASS node. Use a 2.2µF ceramic placed as close to the device as possible.

REF Capacitor Selection

The LM49450 generates an internal low noise reference voltage used by the DAC. For best THD+N performance, bypass REF with 10μ F and 0.1μ F ceramic capacitors.

Charge Pump Capacitor Selection

Use low ESR ceramic capacitors (less than $100m\Omega$) for optimum performance.

Charge Pump Flying Capacitor (C1)

The flying capacitor (C1) affects the load regulation and output impedance of the charge pump. A C1 value that is too low results in a loss of current drive, leading to a loss of amplifier headroom. A higher valued C1 improves load regulation and lowers charge pump output impedance to an extent. Above 2.2μ F, the R_{DS(ON)} of the charge pump switches and the ESR of C1 and C2 dominate the output impedance. A lower value capacitor can be used in systems where low maximum output power requirements.

Charge Pump Hold Capacitor (C2)

The value and ESR of the hold capacitor (C2) directly affects the ripple on CPV_{SS} . Increasing the value of C2 reduces output ripple. Decreasing the ESR of C2 reduces both output ripple and charge pump output impedance. A lower value capacitor can be used in systems where low maximum output power requirements.

Input Capacitor Selection

The LM49450 analog inputs require input coupling capacitors. Input capacitors block the DC component of the audio signal, eliminating any conflict between the DC component of the audio source and the bias voltage of the LM49450. The input capacitors create a high-pass filter with the input resistors R_{IN}. The -3dB point of the high pass filter is found using Equation (1) below.

$$f = 1 / 2\pi R_{IN}C_{IN}$$
(1)

Where the value of R_{IN} is typically 20k Ω .

The input capacitors can also be used to remove low frequency content from the audio signal. Small speakers cannot reproduce, and may even be damaged by low frequencies. High pass filtering the audio signal helps protect the speakers. When the LM49450 is using a single-ended source, power supply noise on the ground is seen as an input signal. Setting the high-pass filter point above the power supply noise frequencies, 217Hz in a GSM phone, for example, filters out the noise such that it is not amplified and heard on the output. Capacitors with a tolerance of 10% or better are recommended for impedance matching and improved CMRR and PSRR.

PCB Layout Guidelines 查询"LM49450"供应商 Minimize trace impedance of the power, ground and all output traces for optimum performance. Voltage loss due to trace resistance between the LM49450 and the load results in decreased output power and efficiency. Trace resistance between the power supply and ground has the same effect as a poorly regulated supply, increased ripple and reduced peak output power. Use wide traces for power supply inputs and amplifier outputs to minimize losses due to trace resistance, as well as route heat away from the device. Proper grounding improves audio performance, minimizes crosstalk between channels and prevents switching noise from interfering with the audio signal. Use of power and ground planes is recommended.

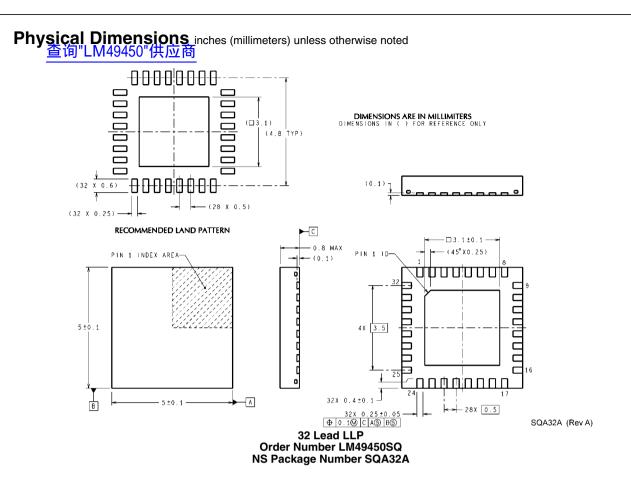
Place all digital components and route digital signal traces as far as possible from analog components and traces. Do not run digital and analog traces in parallel on the same PCB layer. If digital and analog signal lines must cross either over or under each other, ensure that they cross in a perpendicular fashion.

Exposed DAP Mounting Considerations

The LM49450 LLP package features an exposed die-attach (thermal) pad on its backside. The exposed pad provides a direct heat conduction path from the die to the PCB, reducing the thermal resistance of the package. Connect the exposed pad to GND with a large pad and via to a large GND plane on the bottom of the PCB for best heat distribution.

14945(查	Revision Table 询"LM49450"供应	9 商	
		Rev	Date	Description
		1.0	12/18/07	Initial release.
		1.01	09/26/08	Corrected the package drawing.





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Notes

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